



RS3A/B - RS3M/B

3.0A SURFACE MOUNT FAST RECOVERY RECTIFIER

Features

- Glass Passivated Die Construction
- Fast Recovery Time for High Efficiency
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automatic Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMB, SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band or Cathode Notch
- Weight: SMB 0.093 grams (approximate)

SMC 0.21 grams (approximate)





Top View

Bottom View

Ordering Information (Note 3)

Part Number	Case	Packaging
RS3x-13-F	SMC	3000/Tape & Reel
RS3xB-13-F	SMB	3000/Tape & Reel

^{*} x = Device type, e.g. RS3A-13-F (SMC package); RS3AB-13-F (SMB package).

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	RS3 A/AB	RS3 B/BB	RS3 D/DB	RS3 G/GB	RS3 J/JB	RS3 K/KB	RS3 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4)	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T _T = 75°C	lo				3.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}				100				Α

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance Junction to Terminal (Note 5)	SMB SMC	$R_{ heta JT}$	25 11	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-65 to +150	°C

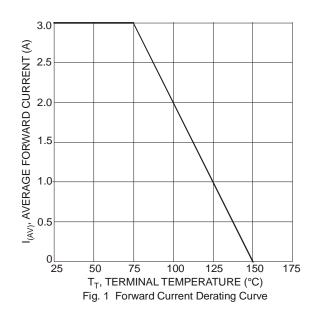
Electrical Characteristics @TA = 25°C unless otherwise specified

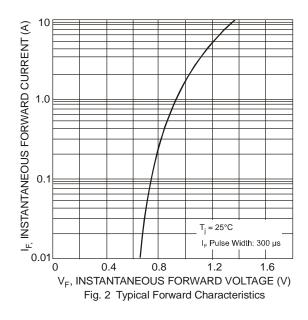
Characteristic		Symbol	RS3 A/AB	RS3 B/BB	RS3 D/DB	RS3 G/GB	RS3 J/JB	RS3 K/KB	RS3 M/MB	Unit
Forward Voltage	@ $I_F = 3.0A$	V_{FM}				1.3				V
Peak Reverse Current	@ T _A = 25°C					5.0				^
at Rated DC Blocking Voltage (Note 4	@ $T_A = 125^{\circ}C$	I _{RM}				250				μΑ
Maximum Recovery Time (Note 6)	•	t _{rr}		15	50		250	50	00	ns
Typical Total Capacitance (Note 7)		Ст				50				pF

Notes:

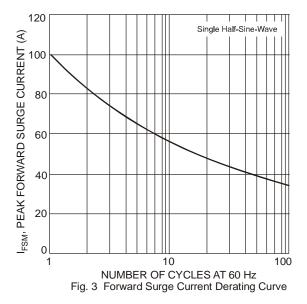
- 4. Short duration pulse test used to minimize self-heating effect.
- 5. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

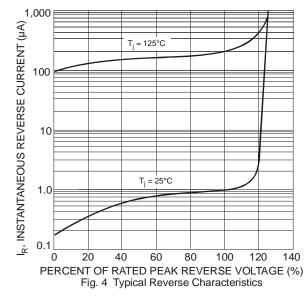
 6. Reverse recovery test conditions: I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See Figure 5.
- 7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

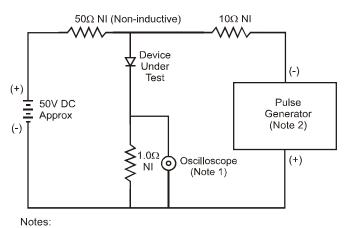


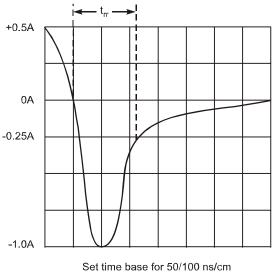








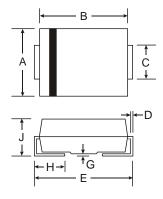




- 1. Rise Time = 7.0ns max. Input Impedance = $1.0M\Omega$, 22pF.
- 2. Rise Time = 10ns max. Input Impedance = 50Ω .

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

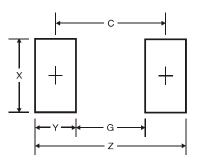


	SMB					
Dim	Min	Max				
Α	3.30	3.94				
В	4.06	4.57				
С	1.96	2.21				
D	0.15	0.31				
E	5.00	5.59				
G	0.05	0.20				
Н	0.76	1.52				
J	2.00	2.50				
All Dim	All Dimensions in mm					

	SMC					
Dim	Min	Max				
Α	5.59	6.22				
В	6.60	7.11				
С	2.75	3.18				
D	0.15	0.31				
Е	7.75	8.13				
G 0.10 0.20						
Н	0.76	1.52				
J	2.00	2.50				
All Dimensions in mm						



Suggested Pad Layout



SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Υ	2.5
С	4.3

SMC Dimensions	Value (in mm)
Z	9.3
G	4.4
Х	3.3
Υ	2.5
С	6.8

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